

HSF

NOTES:

Current Rating: 3.0AMP
 Withstand Voltage: 500V AC/DC
 Contact Resistance: 20mΩ Max
 Insulation Resistance: 1000MΩMin
 Operation Temperature: -40°C to +105°C
 Contact Material: Phosphor Bronze or Brass
 Contact plating: Au or Sn over Ni
 Insulator Material: PA6T or PBT or PBT+30%G.F UL94V-0

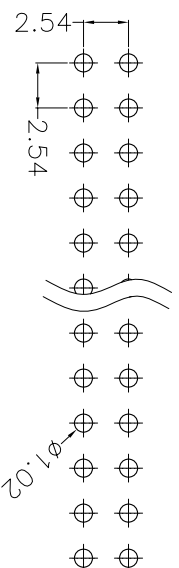
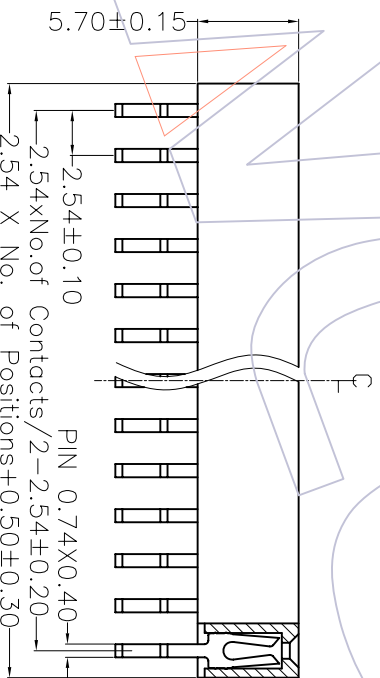
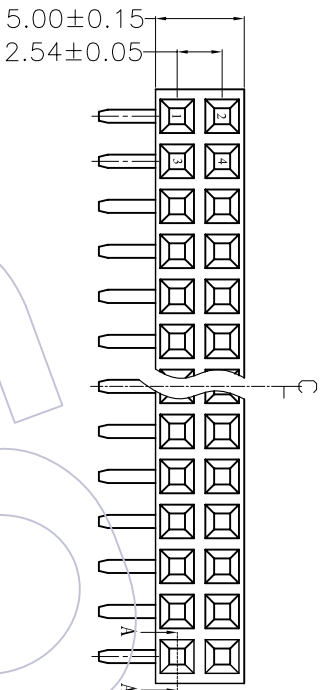
Ordering Information

2157-2 XX R XX X Y N A 1

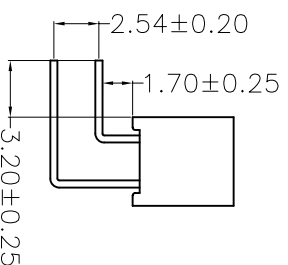
No.of Pins per ROW:02-40PIN
 Contact Plating: G1=9μ Gold
 G2=5μ Gold
 G3=10μ Gold
 G4=15μ Gold
 G5=30μ Gold
 SR=Gold Flash/Tin
 S1=9μ Gold/Tin
 S2=5μ Gold/Tin
 S3=10μ Gold/Tin
 S4=15μ Gold/Tin
 S5=30μ Gold/Tin
 SN=Tin

Insulator: A=PBT
 C=PA6T

Packing: A=Tray
 T=Tube



Recommended P.C.B Layout(TOP Side)
 (PCB BOARD TOLERANCE±0.05)



SECTION: A-A

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	WEIXD	SCALE	PART NO.	TITLE:
A0	08/03/11	NEW			XX ±0.40	DESIGN	08.03.11	4:1	2157-2XXXXXXN1	FH2.54 DUAL 90° H=5.7
					X.XX ±0.25	CHECK		A4		
					X.XXX ±0.15			1/1		
					Angle ± 3'	APPROVE		PROJ.		
					DM				Customer NO.	

WCON 维峰五金电子有限公司
 WAFER HARDWARE ELECTRONICS CO.,LTD